	Application No.	Amulia and/a)	_
Nation of Allowability	Application No.	Applicant(s)	
	09/944,648	DINAN ET AL.	
Notice of Allowability	Examiner	Art Unit	-
	Tianjie Chen	2627	
The MAILING DATE of this communication app All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85 NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT F of the Office or upon petition by the applicant. See 37 CFR 1.31 1. This communication is responsive to RCE filed on 09/16/2	G (OR REMAINS) CLOSED in a common of the com	n this application. If not included unication will be mailed in due course. THIS	- re
This communication is responsive to <u>RCE lifed on 09/10/2</u>	<u>2006</u> .		
2. The allowed claim(s) is/are <u>1-10,19-24</u> .			
3. ☐ Acknowledgment is made of a claim for foreign priority u a) ☐ All b) ☐ Some* c) ☐ None of the: 1. ☐ Certified copies of the priority documents hav 2. ☐ Certified copies of the priority documents hav 3. ☐ Copies of the certified copies of the priority documents have	e been received. e been received in Applicati	on No	
International Bureau (PCT Rule 17.2(a)). * Certified copies not received:			
Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONI THIS THREE-MONTH PERIOD IS NOT EXTENDABLE. 4. A SUBSTITUTE OATH OR DECLARATION must be submin INFORMAL PATENT APPLICATION (PTO-152) which give	MENT of this application. nitted. Note the attached EX	AMINER'S AMENDMENT or NOTICE OF	
_	, ,	A designation to denote the	
5. CORRECTED DRAWINGS (as "replacement sheets") mu		(DTO 040) attached	
 (a) ☐ including changes required by the Notice of Draftsper 1) ☐ hereto or 2) ☐ to Paper No./Mail Date 		w (PTO-948) attached	
(b) ☐ including changes required by the attached Examiner Paper No./Mail Date	=	r in the Office action of	
Identifying indicia such as the application number (see 37 CFR each sheet. Replacement sheet(s) should be labeled as such in			
 DEPOSIT OF and/or INFORMATION about the deposit attached Examiner's comment regarding REQUIREMENT 			
Attachment(s)	_		
1. Notice of References Cited (PTO-892)		nformal Patent Application	
2. Notice of Draftperson's Patent Drawing Review (PTO-948)		Summary (PTO-413), /Mail Date	
3. Information Disclosure Statements (PTO/SB/08), Paper No./Mail Date	7. 🛭 Examiner's	Amendment/Comment	
Examiner's Comment Regarding Requirement for Deposit of Biological Material	8. ⊠ Examiner's	S Statement of Reasons for Allowance	
		TIANJIE CHEN PRIMARY EXAMINER	

Application/Control Number: 09/944,648

Art Unit: 2627

DETAILED ACTION

Page 2

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 02/16/2005 has been entered.

Examiner's Amendment

2. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Robert O. Guillot on 11/20/2006.

The application has been amended as follows:

- In claim 1, lines 6-9 have been replaced by -- a P2 pole tip fabricated upon of the write gap layer, wherein the P2 pole tip consists of a first sidewall portion, which is formed from a seed layer, and a second portion, which is composed of a pole tip material, and wherein the P2 pole tip has a thickness dimension t, and a base having a width dimension W:--.
- In claim 2, line 2; "non-seed layer" has been changed to --pole tip--.
- In claim 2, line 2; "sidewall" has been deleted.
- In claim 3, line 4; "non-seed layer" has been changed to --pole tip--.
- In claim 4, line 2; "non-seed layer" has been changed to --pole tip--.

Application/Control Number: 09/944,648 Page 3

Art Unit: 2627

• In claim 5, line 2; "non-seed layer" has been changed to --pole tip--.

- In claim 6, lines 9-12 has been replaced by -- a P2 pole tip fabricated upon of the write gap layer, wherein the P2 pole tip consists of a first sidewall portion, which is formed from a seed layer, and a second portion, which is composed of a pole tip material, and wherein the P2 pole tip has a thickness dimension t, and a base having a width dimension W;--.
- In claim 7, line 2; "non-seed layer" has been changed to --pole tip--.
- In claim 7, line 2; "sidewall" has been deleted.
- In claim 8, line 4; "non-seed layer" has been changed to --pole tip--.
- In claim 9, line 2; "non-seed layer" has been changed to --pole tip--.
- In claim 10, line 2; "non-seed layer" has been changed to --pole tip--.
- In claim 19, line 11; "non-seed layer" has been changed to --pole tip--.
- In claim 21, line 2; "non-seed layer" has been changed to --pole tip--.
- In claim 22, line 3; "non-seed layer" has been changed to --pole tip--.
- In claim 23, line 2; "non-seed layer" has been changed to --pole tip--.
- In claim 24, line 2; "non-seed layer" has been changed to --pole tip--.
- 3. The following is an examiner's statement of reasons for allowance:
 - With regard to independent claims 1 and 6; as the closest reference, Ohtsuka et al (US 5,774,308) discloses a magnetic head including: a substrate; a read head being fabricated upon the substrate; a P1 pole being fabricated upon the read head; a write gap layer being fabricated upon the P1 pole; a P2 pole tip fabricated upon of the write gap layer, wherein the P2 pole tip has a thickness dimension t, and a base having a width dimension W; and wherein the seed layer is comprised of an integrally formed layer of seed layer material that forms

Application/Control Number: 09/944,648

Art Unit: 2627

the base of the P2 pole tip and the first sidewall portion of the P2 pole tip that extends throughout the thickness t of the P2 pole tip; **but fails to show** a P2

pole tip consists of a first sidewall portion, which is formed from a seed layer,

and a second portion, which is composed of a pole tip material.

• With regard to independent claim 19; as the closest reference, Ohtsuka et al (US 5,774,308) discloses a magnetic head including: a substrate; a read head

being fabricated upon the substrate; a P1 pole being fabricated upon the read

head; a write gap layer being fabricated upon the P1 pole; a P2 pole tip being

fabricated upon portions of the write gap layer, wherein the P2 pole tip includes

a base surface that is disposed upon the write gap layer and a first sidewall

surface layer that is disposed generally perpendicularly to the base surface,

and wherein the base surface layer and the first sidewall surface layer are

comprised of an integrally formed layer of P2 pole tip seed layer material and

wherein the P2 pole tip includes a pole tip layer material portion, and wherein

the P2 pole tip includes a second sidewall surface layer that is disposed

opposite to the first sidewall surface layer; but fails to show that the second

layer is comprised of the pole tip layer material.

• Applicant asserts "the magnetic head of the present invention that it includes a

P2 pole tip having a narrow width" (Specification, p. 3)

4. Any comments considered necessary by applicant must be submitted no later

than the payment of the issue fee and, to avoid processing delays, should preferably

accompany the issue fee. Such submissions should be clearly labeled "Comments on

Statement of Reasons for Allowance."

Page 4

Application/Control Number: 09/944,648

Art Unit: 2627

Any inquiry concerning this communication or earlier communications from the

Page 5

examiner should be directed to Tianjie Chen whose telephone number is 571-272-

7570. The examiner can normally be reached on 8:00-4:30, Mon-Fri.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Hoa Nguyen can be reached on 571-272-7579. The fax phone number for

the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the

Patent Application Information Retrieval (PAIR) system. Status information for

published applications may be obtained from either Private PAIR or Public PAIR.

Status information for unpublished applications is available through Private PAIR

only. For more information about the PAIR system, see http://pair-direct.uspto.gov.

Should you have questions on access to the Private PAIR system, contact the

Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like

assistance from a USPTO Customer Service Representative or access to the automated

information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

TIANJIE CHEN PRIMARY EXAMINER